Docket No.: FP02-211US 11-22-2002 FORM PTO-1595 (Modified) SHEET U.S. DEPARTMENT OF COMMERCE (Rev 03-01) Patent and Trademark Office OMB No. 0651-0027 (exp.5/31/2002) Y PORA/REVO3 Tab settings → → 102289467
Please record the attached original documents or copy thereof. To the Honorable Commissioner o 2. Name and address of receiving party(ies): 1. Name of conveying party(ies): Eiji Kojima MED Name: Sumitomo Wiring Systems, Ltd. Masahide Hio 11-14-07 Hirotaka Makino Address: 1-14, Nishisuehiro-cho ☐ Yes 🏿 No Additional names(s) of conveying party(ies) Nature of conveyance: ★ Assignment Merger City: Yokkaichi-City State/Prov.: Mie Change of Name ☐ Security Agreement Country: JAPAN ZIP: 510-8503 ☐ Other Execution Date: November 12, 2002 ⊠ No Additional name(s) & address(es) ☐ Yes Application number(s) or patent numbers(s): If this document is being filed together with a new application, the execution date of the application is: November 12, 2002 B. Patent No.(s) Filing date Patent Application No. 10 294784 ☐ Yes 🛛 No Additional numbers 5. Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: 7. Total fee (37 CFR 3.41):....\$ 40.00 Name: Gerald E. Hespos ☑ Enclosed - Any excess or insufficiency should be 30,066 Registration No. credited or debited to deposit account Address: 274 Madison Avenue - Suite 1703 ☐ Authorized to be charged to deposit account 11/21/2002 GTON11 00000153 10294784 8. Deposit account number: VOE 40.00 DP 01 FC:8021 03-1030 State/Prov.: NY City: New York (Attach duplicate copy of this page if paying by deposit account) ZIP: 10016 Country: USA DO NOT USE THIS SPACE To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy 9. Statement and signature. November 14, 2002 of the original document. Gerald E. Hespos Date Signature Name of Person Signing Total number of pages including cover sheet, attachments, and

> PATENT REEL: 013498 FRAME: 0845

Atty. Ref.: FP62-2114

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned by the Assignee, Sumitomo Wiring Systems, Ltd., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503 Japan, receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers and sets over unto the said assignee the entire right, title and interest in and to the invention or improvement entitled "A TERMINAL FITTING AND A METHOD FOR FORMING IT", said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefor may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries at its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patents which may be granted therefor in said Assignee, its successors, assigns or other legal representatives, and, upon the request and at the expense of said assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of any Letters Patents to be granted therefor, and will make all rightful caths and do all lawful acts requisite for procuring the same or for aiding therein, without further compensation, but at the expense of said assignee, its successors, assigns or other legal representatives.

And The Commissioner Of Patents is Hereby Authorized And Requested to issue any and all Letters Patent of the United States for said invention, to said assignee.

Signed and sealed this 12 day of hornwhere 2002. Hirotaka Makino Hirotaka Makino

PATENT REEL: 013498 FRAME: 0846

RECORDED: 11/14/2002